

GP-XFP-1Z-CW510-OPC

Dell Force10® GP-XFP-1Z-CW510 Compatible TAA 10GBase-CWDM XFP Transceiver (SMF, 1510nm, 80km, LC, DOM)

Features

- INF-8077i Compliance
- Duplex LC Connector
- Single-mode Fiber
- Commercial Temperature 0 to 70 Celsius
- Hot Pluggable
- Metal with Lower EMI
- Excellent ESD Protection
- RoHS Compliant and Lead Free



Applications:

- 10x Gigabit Ethernet over CWDM
- 8x/10x Fibre Channel
- Access, Metro and Enterprise
- Mobile Fronthaul CPRI/OBSAI

Product Description

This Dell Force10® GP-XFP-1Z-CW510 compatible XFP transceiver provides 10GBase-CWDM throughput up to 80km over single-mode fiber (SMF) using a wavelength of 1510nm via an LC connector. It can operate at temperatures between 0 and 70C. The listed reach has been determined using a link budget calculation and tested in a standard environment. Actual link distances achieved will be dependent upon the deployed environment. Our transceiver is built to meet or exceed OEM specifications and is guaranteed to be 100% compatible with Dell Force10®. It has been programmed, uniquely serialized, and tested for data-traffic and application to ensure that it will initialize and perform identically. All of our transceivers comply with Multi-Source Agreement (MSA) standards to provide seamless network integration. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

Regulatory Compliance

- ESD to the Electrical PINs: compatible with MIL-STD-883E Method 3015.7.
- ESD to the Duplex LC Receptacle: compatible with IEC 61000-4-2
- Immunity compatible with IEC 61000-4-3.
- EMI compatible with FCC Part 15 Class B EN55022 Class B (CISPR 22B) VCCI Class B.
- Laser Eye Safety compatible with FDA 21CFR 1040.10 and 1040.11 EN60950, EN (IEC) 60825-1,2.
- RoHs compliant with 2002/95/EC 4.1&4.2 2005/747/EC.

CWDM Available Wavelengths

Wavelengths	Min.	Typ.	Max.
1270	1263.5	1270	1276.5
1290	1283.5	1290	1296.5
1310	1303.5	1310	1316.5
1330	1323.5	1330	1336.5
1350	1343.5	1350	1356.5
1370	1363.5	1370	1376.5
1390	1383.5	1390	1396.5
1410	1403.5	1410	1416.5
1430	1423.5	1430	1436.5
1450	1443.5	1450	1456.5
1470	1463.5	1470	1476.5
1490	1483.5	1490	1496.5
1510	1503.5	1510	1516.5
1530	1523.5	1530	1536.5
1550	1543.5	1550	1556.5
1570	1563.5	1570	1576.5
1590	1583.5	1590	1596.5
1610	1603.5	1610	1616.5

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Maximum Supply Voltage	Vcc3	-0.5	4.0	V
	Vcc5	-0.5	6.0	
Storage Temperature	TS	-40	85	°C
Operating Humidity	RH	5	85	%
Case Operating Temperature – Commercial	Tc	0	70	°C
Case Operating Temperature – Industrial	Tc	-40	85	°C
50/125µm MMF (OM3)	Lmax		70	km

Electrical Characteristics (TOP=25°C, Vcc=3.3Volts)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Power Supply Voltage	Vcc3	3.13	3.30	3.47	V	
	Vcc5	4.75	5.0	5.25		
Power Supply Current	Icc3			750	mA	
	Icc5			500		
Transmitter						
Differential data input swing	Vin,pp	120	600	850	mV	
Input differential impedance	Zin	90	100	110	Ω	
Receiver						
Differential data output swing	Vout, pp	300	600	850	mV	
Output differential impedance	Zin	90	100	110	Ω	
Transceiver						
Ref-clk input swing	Ref,pp	400		2400	mV	
TX Disable-High		2.0		Vcc+0.3	V	
TX Disable-Low		Vee-0.3		0.8	V	
LOS-High		2.0		Vcc+0.3	V	
LOS-Low		Vee-0.3		0.8	V	
MOD_DESEL-High		2.0		Vcc+0.3	V	
MOD_DESEL-Low		Vee-0.3		0.8	V	
MOD_INT-High		2.0		Vcc+0.3	V	
MOD_INT-Low		Vee-0.3		0.8	V	
MOD_NR-High		2.0		Vcc+0.3	V	

MOD_NR-Low		Vee-0.3		0.8	V	
P_DOWN/RST-High		2.0		Vcc+0.3	V	
P_DOWN/RST-Low		Vee-0.3		0.8	V	

Notes:

1. Maximum total power value is specified across the full temperature and voltage range and the inrush current is included.

Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Transmitter						
Operating Data Rate		9.95		11.3		
Output Opt. Power	PO	0		4	dBm	
Center Wavelength Spacing			100		GHZ	
Optical Wavelength	λ	1xx1-6.5	1xx1	1xx1+6.5	nm	3
Side Mode Suppression Ratio	SMSR	30			dB	
Optical Extinction Ratio	ER	9			dB	
Generation Jitter 1(20KHZ-80MHZ)				0.3	Ulp-p	1
Generation Jitter 2(4MHZ-80MHZ)				0.1	Ulp-p	1
Dispersion penalty (@1450ps/nm, non-FEC rate)				2	dB	4
Dispersion penalty (@1300ps/nm, FEC rate)				3	dB	4
Optical Eye Mask 1			ITU-T G.691			1
Optical Eye Mask 2			IEEE802.3ae			2
Receiver						
Overload		-8			dBm	
Optical Center Wavelength	λ_C	1270		1600	nm	
LOS De-Assert	LOSD			-26	dBm	
LOS Assert	LOSA	-34			dBm	
LOS Hysteresis		0.5		5	dB	
Receiver Sensitivity @non-FEC rate	Pmin1			-23	dBm	4
Receiver Sensitivity @ FEC rate	Pmin2			-27	dBm	4

Notes:

2. Measured at 9.9532GBs, PRBS³¹⁻¹, NRZ.

3. Measured at 10.3125Gbs, Non-framed PRBS2³¹-1, NRZ.
4. XX= CWDM Wavelength
5. Non-FEC rate refers 9.9/10.3/10.5 Gbs, and FEC rate refers 10.7/11.1/11.3 Gbs, BER of 1E-12 for non-FEC rate, and 1E-4 for FEC rate.

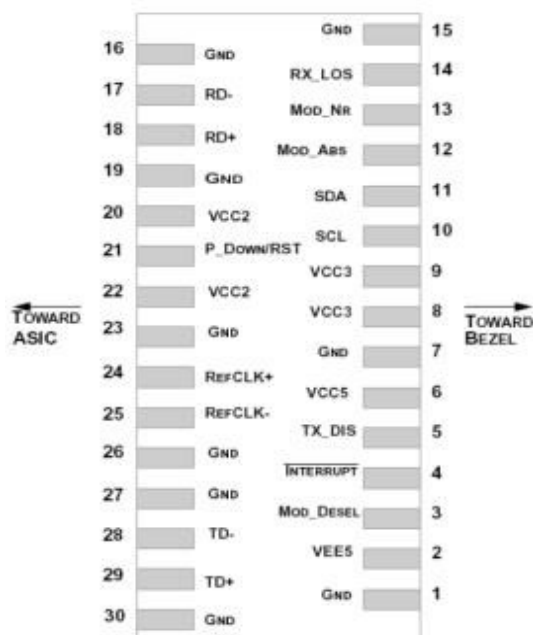
Pin Descriptions

Pin	Symbol	Name/Descriptions	Ref.
1	GND	Module Ground	
2	Vee5	(not required)	
3	MOD_DESEL	Module De-select; When Held low allows the module to respond to 2-wire serial interface. LVTTTL-I	
4	/INTERRUPT	Interrupt; Indicates presence of an important condition which can be read via the 2-wire serial interface. LVTTTL-O	2
5	TX_DIS	Transmitter Disable. Logic1 indicates laser output disabled, LVTTTL-I	
6	VCC5	+5V Power Supply (Not required)	
7	GND	Module Ground	1
8	VCC3	+3.3V Power Supply	
9	VCC3	+3.3V Power Supply	
10	SCL	2-Wire Serial Interface Clock. LVTTTL-I	2
11	SDA	2-Wire Serial Interface Data Line. LVTTTL-I/O	2
12	MOD_Abs	Indicates Module is not present. Grounded in the Module. LVTTTL-O	2
13	MOD_NR	Module Not Ready; Indicating Module Operational Fault. Open-collector. LVTTTL-O	2
14	RX_LOS	Loss of Signal indication. Logic 1 indicates loss of Signal. Open-collector. LVTTTL-O	2
15	GND	Module Ground	1
16	GND	Module Ground	1
17	RD-	Receiver Inverted Data Output. CML-O	
18	RD+	Receiver Non-Inverted Data Output. CML-O	
19	GND	Module Ground	1
20	VCC2	+1.8V Power Supply (Not required).	3
21	P_DOWN/RST	Power down; When high, requires the module to limit power consumption to 1.5W or below. 2-Wire serial interface must be functional in the low power mode. LVTTTL-I	
		Reset; The falling edge initiates a complete reset of the module including the 2wire serial interface, equivalent to a power cycle. LVTTTL-I	
22	VCC2	+1.8V Power Supply (Not required)	3
23	GND	Module Ground	1
24	REFCLK+	Reference Clock (Not required)	

25	REFCLK-	Reference Clock (Not required)	
26	GND	Module Ground	1
27	GND	Module Ground	1
28	TD-	Transmitter Inverted Data Input. CML-I	
29	TD+	Transmitter Non-Inverted Data Input. CML-I	
30	GND	Module Ground	1

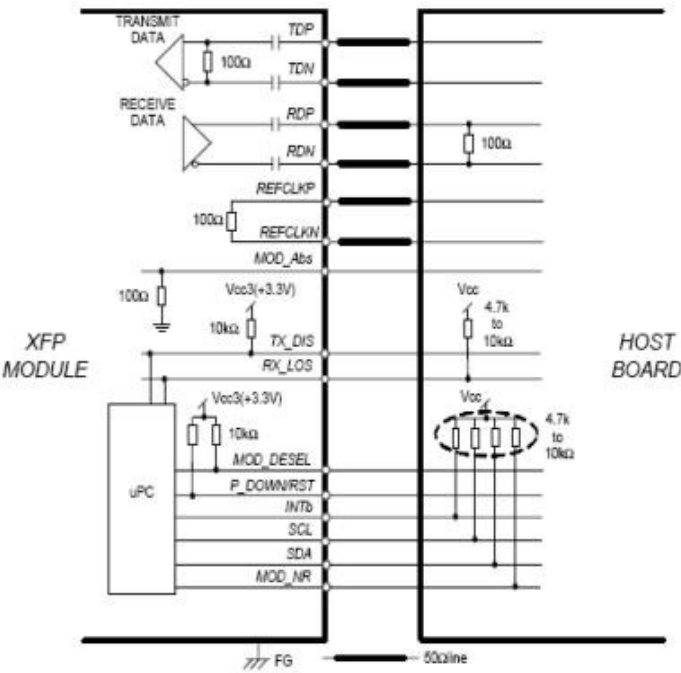
Notes:

1. Module ground pins GND are isolated from the module case and chassis ground within the module.
2. Open collector; should be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.6V on the host board.
3. The pins are open within module.

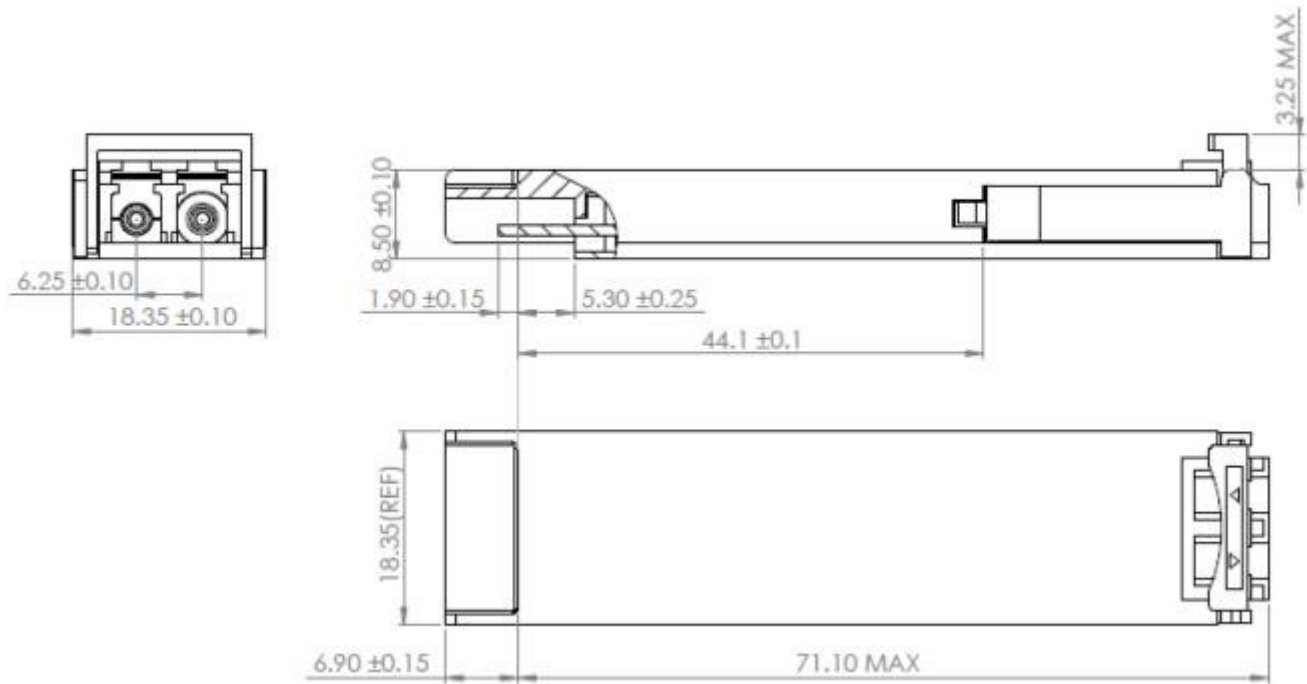


Pin-out of connector Block on Host board

Recommend Circuit Schematic



Mechanical Specifications

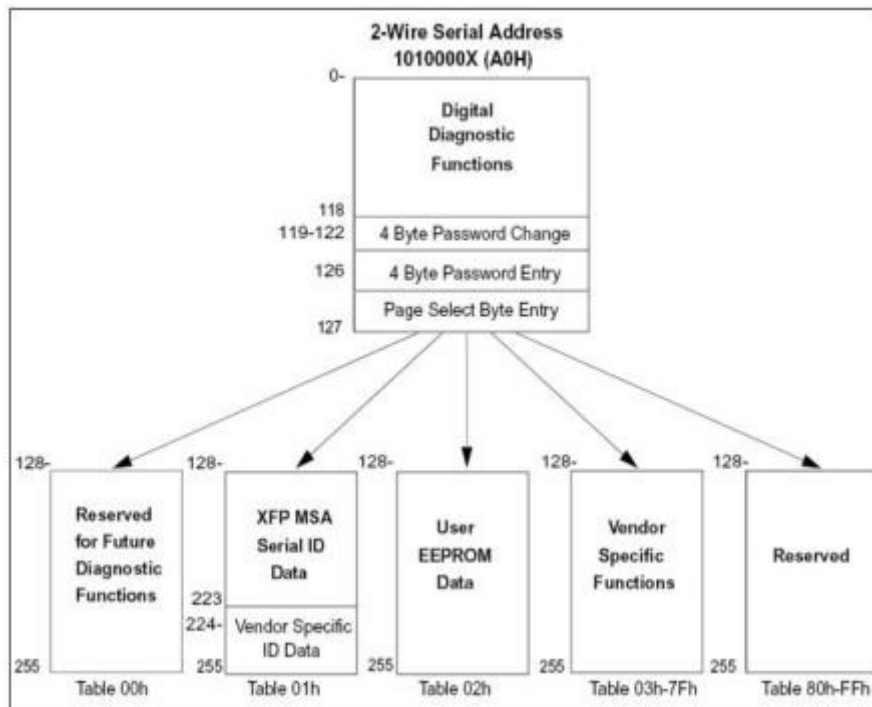


Management Interface

XFP 2-wire serial interface is specified in the Chapter 4 of the XFP MSA specification. The XFP 2-wire serial interface is used for serial ID, digital diagnostics, and certain control functions. The 2-wire serial interface is mandatory for all XFP modules. The 2-wire serial interface address of the XFP module is 1010000X(A0h). In order to access to multiple modules on the same 2-wire serial bus, the XFP has a MOD_DESEL(module deselect pin). This pin (which is pull high or deselected in the module) must be held low by the host to select of interest and allow communication over 2-wire serial interface. The module must not respond to or accept 2-wire serial bus instructions unless it is selected.

XFP Management Interface

XFP Management interface is specified in the Chapter 5 of the XFP MSA specification. The Figure 1 shows the structure of the memory map. The normal 256 Byte address space is divided into lower and upper blocks of 128 Bytes. The lower block of 128 Byte is always directly available and is used for the diagnostics and control functions that must be accessed repeatedly. Multiple blocks of memories are available in the upper 128 Bytes of the address space. These are individually addressed through a table select Byte which the user enters into a location in the lower address space. The upper address space tables are used for less frequently accessed functions and control space for future standards definition.



Digital Diagnostic Monitoring Interface

The digital diagnostic monitoring interface also defines another 256-byte memory map in EEPROM, which makes use of the 8 bit address 1010001X (A2h). The monitoring specification of this product is described in this table.

Parameter	Range	Accuracy	Calibration
Temperature	0°C to 70°C (C)	±3°C	Internal
Voltage	2.97V to 3.63V 4.73 to 5.25V	±3%	Internal
Bias Current	0mA to 100mA	±10%	Internal
TX Power	0dBm to 4dBm	±2dB	Internal
RX Power	-24dBm to -8dBm	±2dB	Internal